ATXK-H11

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3.28 x 2.58 x 1.36 mm **RoHS/RoHS II Compliant** MSL Level = 1

Features

- Frequency Stability options: ± 3.8 ppm over -10 to ± 60 °C, $\pm 5.0 ppm$ over -40 to +85°C, & $\pm 8.0 ppm$ over -40 to +105°C
- Output waveform CMOS
- Low power consumption
- Supply Voltage options: 3.3V and 2.5V

Applications

- Frequency reference for real time clocks (RTCs)
- Portable & wearable electronics
- Internet of Things (IoT)
- Consumer electronics
- Timing synchronization for networks, servers, hubs, routers & switches

Electrical Specifications [Note 1]

Paramo	eters	Min.	Тур.	Max.	Units	Notes
Frequency (fc)			32.768		kHz	
Operating Temperature Range		-40		+105	°C	See Options
Storage Temperature	Range	-55		+105	°C	
Frequency Stability	$\Delta f/f_o$ vs:					
	Tolerance	-2.5		+2.5		Reference to fc (at 25°C±2°C), Pre-reflow
	Tolerance			+3.0	ppm	Reference to fc (at 25°C ±2°C), 24 hours after reflow, one time
Temperature		-5.0		+5.0		See Options Reference to frequency tolerance reading (fo) at 25°C ±2°C
	Load Change	-0.2		+0.2		Load ± 10%
Supply Voltage Change		-1.0		+1.0	ppm/V	
Aging		-3.0		+3.0	ppm	First year at +25°C±2°C
Timing error over time (±5 ppm over -40°C to +85°C)		±0.432 sec/day; ±12.960 sec/month; ±2.628 minutes/year				Reference to frequency tolerance reading (fo) at 25°C ±2°C
		+3.135	+3.3	+3.465	V	Option E
Supply Voltage (VDD)	+2.375	+2.5	+2.625		Option C
Supply Current (I _{DD})			1.0	2.0	μA	Without load
Disable Current				1.0	μA	Pad 1 logic low
Start-up Time				0.5	sec	
Rise and Fall Time (Tr/Tf)				100	ns	20% to 80% of waveform,15pF Load
Symmetry @ ½ V _{DD}		40		60	%	
	Voh	$90\%V_{DD}$			V	
Output Voltage	V_{OL}			$10\%V_{DD}$		
Output Load			_	15	рF	CMOS
Output Waveform		CMOS				
Tri-state function [Note 2]		"1" (VIH≥0.8*VDD): Oscillation; "0" (VIL<0.2*VDD): No Oscillation/Hi Z		V		

All measurements made over specified operating temperature range, at nominal V_{DD}, and 15pf load, unless otherwise specified. Note 1:

Note 2: Do not leave pad 1 (tri-state) floating (no connect). Pad 1 must be tied to Vdd (logic 1) for proper oscillation on pad 3.



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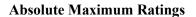
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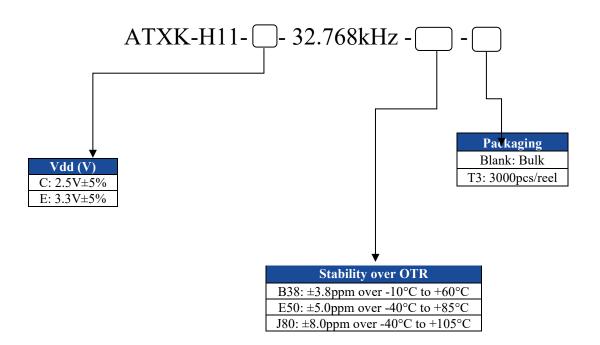


Parameters	Symbol	Conditions	Rating	Unit
Supply voltage range (3)	V_{DD}	Between V _{DD} and V _{SS}	-0.3 to +4.5	V
Input voltage range (3)	VIN	Between INH and V _{SS}	-0.3 to V _{DD} +0.3 (4)	V
Output voltage range (3)	VOUT	Output pad	-0.3 to V _{DD} +0.3 (4)	V
Junction temperature (3)	Tj	-	150	°C
Storage temperature range	TSTG	-	-55 to +105	°C

Absolute maximum ratings are the values that must not be exceeded. This product may suffer damage if any one of these parameter Note 3: ratings is exceeded. Operation and characteristics are guaranteed only when the product is operated per the specification datasheet.

Note 4: V_{DD} is a V_{DD} value of recommended operating conditions.

Part Identification





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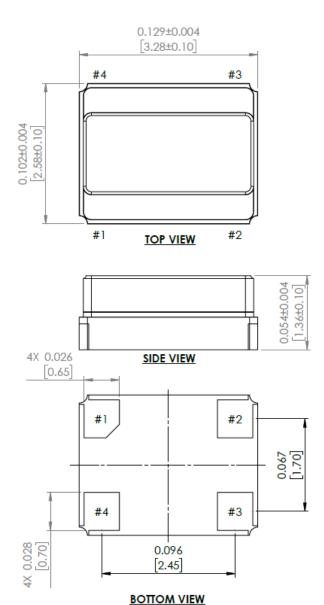


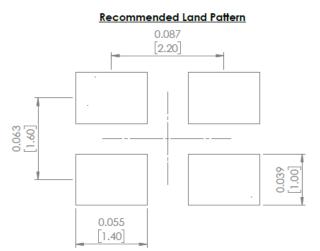




3.28 x 2.58 x 1.36 mm **RoHS/RoHS II Compliant** MSL Level = 1

Mechanical Dimensions





Pin#	Function		
1	Output Enable		
2	GND		
3	Output		
4	$V_{ m DD}$		

Dimensions: inches (mm)



T_p.

 $T_{L^{\prime}}$

Temperature

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Time 25°C to Peak

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Reflow Profile [JDEC J-STD-020]

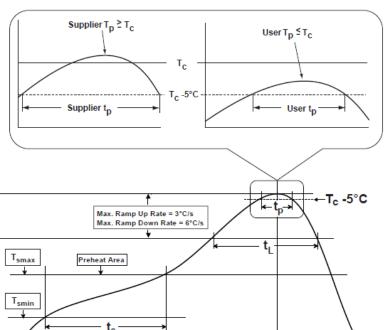


Table 1

SnPb Eutectic Process Classification Temperatures (Tc)				
Package Thickness	Volume mm³ <350	Volume mm³ ≥350		
<2.5 mm	235 °C	220 °C		
>2.5 mm	220 °C	220 °C		

Table 2

Pb-Free Process Classification Temperatures (T _c)				
Package Thickness	Volume mm ³ <350	Volume mm ³ 350-2000	Volume mm³ >2000	
<1.6 mm	260 °C	260 °C	260 °C	
1.6 mm - 2.5 mm	260 °C	250 °C	245 °C	
>2.5 mm	250 °C	245 °C	245 °C	

Profile Feature	Sn-Pb Eutectic Assembly	Pb-Free Assembly
Preheat / soak		
Temperature minimum (T _{smin})	100°C	150°C
Temperature maximum (T _{smax})	150°C	200°C
Time $(T_{smin} \text{ to } T_{smax})$ (t_s)	60 - 120 sec.	60 - 120 sec.
Average ramp-up rate $(T_{smax} \text{ to } T_P)$	3°C/sec. max	3°C/sec. max
Liquidous temperature (T _L)	183°C	217°C
Time at liquidous (t _L)	60 - 150 sec.	60 - 150 sec.
Peak package body temperature (T _P)*	see Table 1	see Table 2
Time $(t_p)^{**}$ within 5°C of the specified classification temperature (T_C)	20 sec.	30 sec.
Ramp-down rate (T _p to T _{smax})	6°C/sec. max	6°C/sec. max
Time 25°C to peak temperature	6 min. max	8 min. max

^{*}Tolerance for peak profile temperature (TP) is defined as a supplier minimum and a user maximum.

Time ⇒



^{**}Tolerance for time at peak profile temperature (tp) is defined as supplier minimum and a user maximum.

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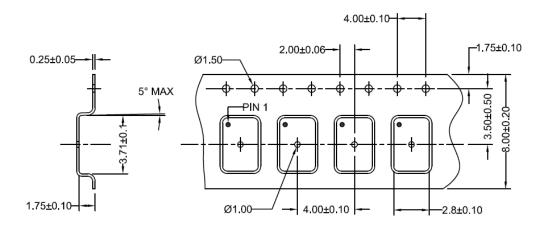
ESD Sensitive



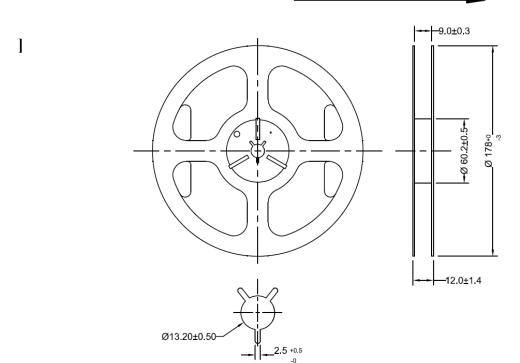
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Packaging

T3: 3,000pcs/reel



FEEDING (PULL) DIRECTION



Dimensions: mm

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